



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

## Quad smart power solid state relay for complete H-bridge configurations

### Features

Type	R <sub>DS(on)</sub>	I <sub>OUT</sub>	V <sub>CC</sub>
VN770K	220 mΩ <sup>(1)</sup>	9 A <sup>(2)</sup>	36 V

1. Total resistance of one side in bridge configuration
2. Typical current limitation value

- Suited as low voltage bridge
- Linear current limitation
- Very low standby power dissipation
- Short circuit protected
- Status flag diagnostic (open drain)
- Integrated clamping circuits
- Undervoltage protection
- ESD protection

### Description

The VN770K is a device formed by three monolithic chips housed in a standard SO-28 package: a double high side and two low side switches. Both the double high side and low side switches are made using STMicroelectronics VIPower™ M0-3 Technology.



This device is suitable to drive a DC motor in a bridge configuration as well as to be used as a quad switch for any low voltage application.

The dual high side switches have built-in thermal shutdown to protect the chips from over temperature and current limiter blocks to protect the device from short circuit. Status output is provided to indicate open load in off and on-state and over temperature.

The low side switches are two OMNIFET II types (fully auto protected Power MOSFET in VIPower™ technology). They have built-in thermal shutdown, linear current limitation and overvoltage clamping. Fault feedback for thermal intervention can be detected by monitoring the voltage at the input pin.

**Table 1. Device summary**

Package	Order codes	
	Tube	Tape and reel
SO-28	VN770K	VN770K13TR

# Contents

<b>1</b>	<b>Block diagrams and pins descriptions</b>	<b>6</b>
<b>2</b>	<b>Electrical specifications</b>	<b>8</b>
2.1	Thermal data	8
2.2	Absolute maximum ratings	8
2.3	Electrical characteristics for dual high side switch	9
2.4	Electrical characteristics for low side switches	11
2.5	Dual high-side switch timing data	14
2.6	Electrical characterization for dual high side switch	16
2.7	Electrical characterization for low side switches	19
<b>3</b>	<b>Application recommendations</b>	<b>23</b>
<b>4</b>	<b>Thermal data</b>	<b>26</b>
4.1	SO-28 thermal data	26
4.2	Thermal calculation in clockwise and anti-clockwise operation in steady state mode	27
4.2.1	Thermal resistances definition	27
4.2.2	Thermal calculation in transient mode	27
4.2.3	Single pulse thermal impedance definition	27
4.2.4	Pulse calculation formula	27
<b>5</b>	<b>Package mechanical data</b>	<b>30</b>
5.1	SO-28 mechanical data	30
5.2	SO-28 tube shipment	31
5.3	Tape and reel shipment	31
<b>6</b>	<b>Revision history</b>	<b>32</b>

## List of tables

Table 1.	Device summary . . . . .	1
Table 2.	Pin definition and function. . . . .	7
Table 3.	Thermal data. . . . .	8
Table 4.	Dual high side switch . . . . .	8
Table 5.	Low side switch. . . . .	8
Table 6.	Power outputs (per each channel) . . . . .	9
Table 7.	Switching (per each channel) ( $V_{CC} = 13V$ ) . . . . .	10
Table 8.	Logic input (per each channel) . . . . .	10
Table 9.	Status pin (per each channel) . . . . .	10
Table 10.	Protections (per each channel) . . . . .	10
Table 11.	Openload detection (per each channel) . . . . .	11
Table 12.	Off-state . . . . .	11
Table 13.	On-state . . . . .	12
Table 14.	Dynamic . . . . .	12
Table 15.	Switching . . . . .	12
Table 16.	Source drain diode . . . . .	13
Table 17.	Protections . . . . .	13
Table 18.	Truth table. . . . .	14
Table 19.	Thermal calculation in clockwise and anti-clockwise operation in steady state mode . . . . .	27
Table 20.	Thermal parameters . . . . .	29
Table 21.	SO-28 mechanical data . . . . .	30
Table 22.	Document revision history . . . . .	32

# List of figures

Figure 1.	Block diagram . . . . .	6
Figure 2.	Connection diagram . . . . .	7
Figure 3.	Switching time waveforms . . . . .	14
Figure 4.	Open-load status timing (with external pull-up) . . . . .	15
Figure 5.	Over temperature status timing . . . . .	15
Figure 6.	Off-state output current . . . . .	16
Figure 7.	Input clamp voltage . . . . .	16
Figure 8.	High level input current . . . . .	16
Figure 9.	Input high level voltage . . . . .	16
Figure 10.	Input low level voltage . . . . .	16
Figure 11.	Input hysteresis voltage . . . . .	16
Figure 12.	Overtoltage shutdown . . . . .	17
Figure 13.	$I_{LIM}$ vs $T_{case}$ . . . . .	17
Figure 14.	Turn-on voltage slope . . . . .	17
Figure 15.	Turn-off voltage slope . . . . .	17
Figure 16.	On-state resistance vs $T_{case}$ . . . . .	17
Figure 17.	On-state resistance vs $V_{CC}$ . . . . .	17
Figure 18.	Status leakage current . . . . .	18
Figure 19.	Status low output voltage . . . . .	18
Figure 20.	Openload on-state detection threshold . . . . .	18
Figure 21.	Openload off-state voltage detection threshold . . . . .	18
Figure 22.	Status clamp voltage . . . . .	18
Figure 23.	Static drain source on resistance . . . . .	19
Figure 24.	Derating curve . . . . .	19
Figure 25.	Transconductance . . . . .	19
Figure 26.	Transfer characteristics . . . . .	19
Figure 27.	Turn-on current slope ( $V_{in}=5V$ ) . . . . .	19
Figure 28.	Turn-on current slope ( $V_{in}=3.5V$ ) . . . . .	19
Figure 29.	Input voltage vs input charge . . . . .	20
Figure 30.	Capacitance variations . . . . .	20
Figure 31.	Switching time resistive load ( $V_{in}=5V$ ) . . . . .	20
Figure 32.	Switching time resistive load ( $R_g=10\text{Ohm}$ ) . . . . .	20
Figure 33.	Output characteristics . . . . .	20
Figure 34.	Step response current limit . . . . .	20
Figure 35.	Source drain diode forward characteristics . . . . .	21
Figure 36.	Static drian source on resistance vs $I_d$ . . . . .	21
Figure 37.	Static drain source on resistance vs input voltage ( $I_d=7A$ ) . . . . .	21
Figure 38.	Static drain source on resistance vs input voltage . . . . .	21
Figure 39.	Normalized input threshold voltage vs temperature . . . . .	21
Figure 40.	Normalized on resistance vs temperature . . . . .	21
Figure 41.	Turn-off drain source voltage slope ( $V_{in}=3.5V$ ) . . . . .	22
Figure 42.	Turn-off drain source voltage slope ( $V_{in}=5V$ ) . . . . .	22
Figure 43.	Current limit vs junction temperature . . . . .	22
Figure 44.	Application diagram bridge drivers . . . . .	23
Figure 45.	Recommended motor operation . . . . .	24
Figure 46.	Waveforms . . . . .	25
Figure 47.	SO-28 PC board . . . . .	26
Figure 48.	Chipset configuration . . . . .	26

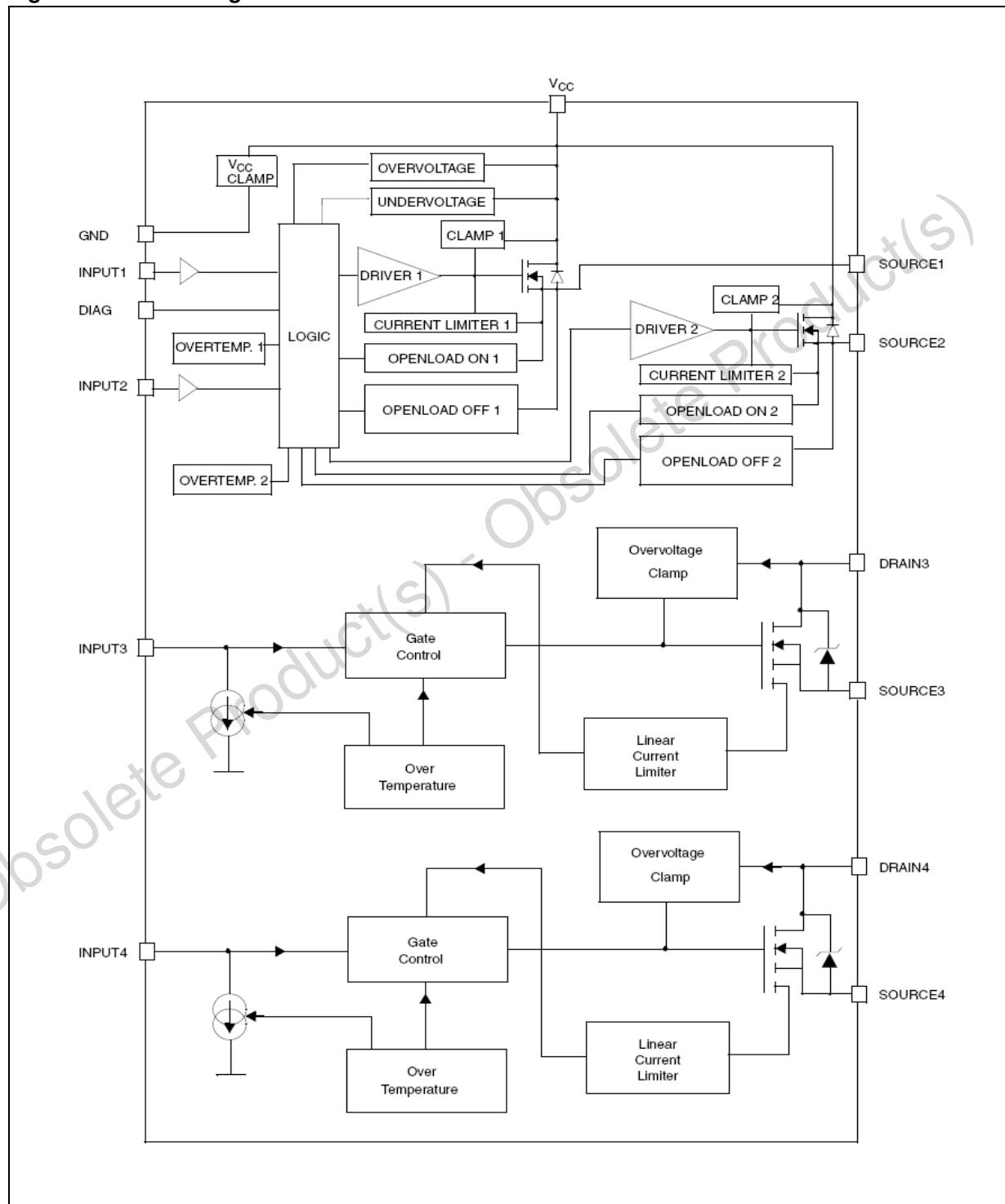
---

Figure 49.	Auto and mutual Rthj-amb vs PCB copper area in open box free air condition . . . . .	26
Figure 50.	SO-28 HSD thermal impedance junction ambient single pulse . . . . .	28
Figure 51.	SO-28 LSD thermal impedance junction ambient single pulse. . . . .	28
Figure 52.	Thermal fitting model of an H-bridge in SO-28 . . . . .	29
Figure 53.	SO-28 package outline . . . . .	30
Figure 54.	Tube dimensions (no suffix) . . . . .	31
Figure 55.	Tape and reel dimensions (suffix "13TR") . . . . .	31

Obsolete Product(s) - Obsolete Product(s)

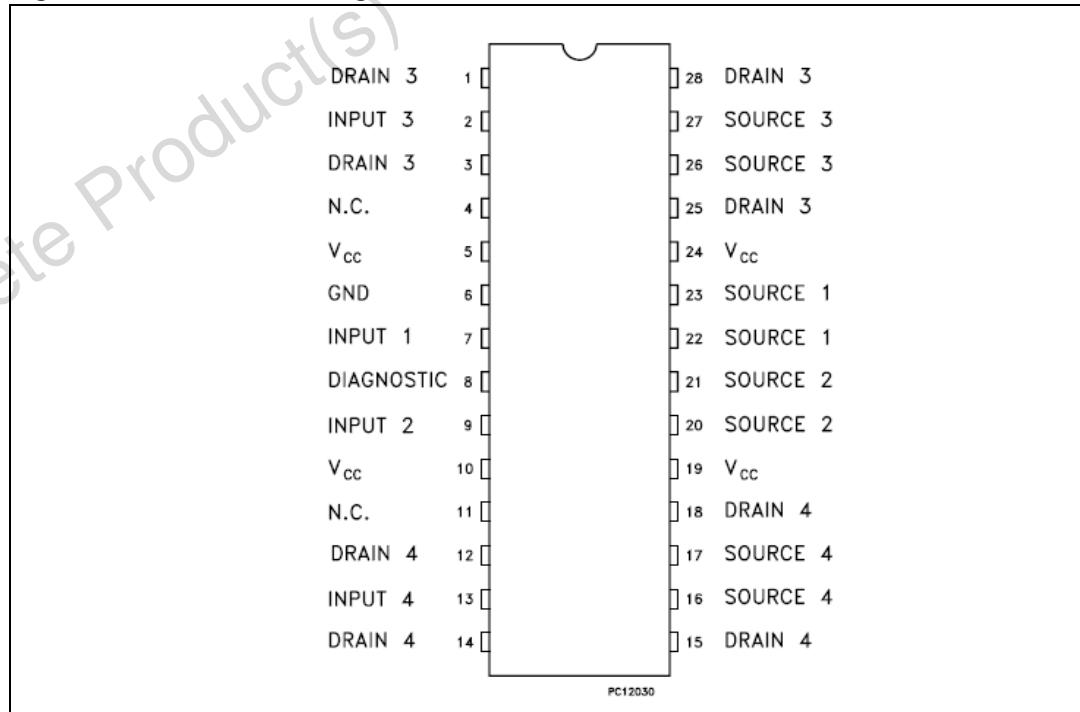
# 1 Block diagrams and pins descriptions

Figure 1. Block diagram



**Table 2. Pin definition and function**

No	Name	Function
1, 3, 25, 28	DRAIN 3	Drain of switch 3 (low-side switch)
2	INPUT 3	Input of switch 3 (low-side switch)
4, 11	N.C.	Not connected
5, 10, 19, 24	V <sub>CC</sub>	Drain of switches 1 and 2 (high-side switches) and power supply voltage
6	GND	Ground of switches 1 and 2 (high-side switches)
7	INPUT 1	Input of switch 1 (high-side switches)
8	DIAGNOSTIC	Diagnostic of switches 1 and 2 (high-side switches)
9	INPUT 2	Input of switch 2 (high-side switch)
12, 14, 15, 18	DRAIN 4	Drain of switch 4 (low-side switch)
13	INPUT 4	Input of switch 4 (low-side switch)
16, 17	SOURCE 4	Source of switch 4 (low-side switch)
20, 21	SOURCE 2	Source of switch 2 (high-side switch)
22, 23	SOURCE 1	Source of switch 1 (high-side switch)
26, 27	SOURCE 3	Source of switch 3 (low-side switch)

**Figure 2. Connection diagram**

## 2 Electrical specifications

### 2.1 Thermal data

**Table 3. Thermal data**

Symbol	Parameter	Value Max (°C/W)
$R_{thj\text{-case}}$	Thermal resistance junction-case (high side switch)	20
$R_{thj\text{-case}}$	Thermal resistance junction-case (low side switch)	20
$R_{thj\text{-amb}}$	Thermal resistance junction-ambient (with 6 cm <sup>2</sup> of Cu heat sink)	See <a href="#">Figure 49</a>

### 2.2 Absolute maximum ratings

**Table 4. Dual high side switch**

Symbol	Parameter	Value	Unit
$V_{CC}$	DC supply voltage	41	V
$-V_{CC}$	Reverse DC supply voltage	-0.3	V
$-I_{GND}$	DC reverse ground pin current	-200	mA
$I_{OUT}$	DC output current	Internally limited	A
$-I_{OUT}$	Reverse DC output current	-6	A
$I_{IN}$	DC input current	$\pm 10$	mA
$I_{STAT}$	DC status current	$\pm 10$	mA
$V_{ESD}$	Electrostatic discharge (human body model: $R = 1.5\text{K}\Omega$ ; $C = 100\text{pF}$ ) – Input – Status – Output – Vcc	4000 4000 5000 5000	V V V V
$P_{tot}$	Power dissipation ( $T_c = 25^\circ\text{C}$ )	6	W
$T_j$	Junction operating temperature	Internally limited	$^\circ\text{C}$
$T_c$	Case operating temperature	-40 to 150	$^\circ\text{C}$
$T_{stg}$	Storage temperature	-55 to 150	$^\circ\text{C}$

**Table 5. Low side switch**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain source voltage ( $V_{IN} = 0\text{V}$ )	Internally clamped	V
$V_{IN}$	Input voltage	Internally clamped	V
$I_{IN}$	Input current	$\pm 20$	mA

**Table 5. Low side switch (continued)**

Symbol	Parameter	Value	Unit
$R_{IN\ MIN}$	Minimum input series impedance	150	$\Omega$
$I_D$	Drain current	Internally limited	A
$I_R$	Reverse DC output current	-10.5	A
$V_{ESD1}$	Electrostatic discharge ( $R = 1.5K\Omega$ , $C = 100pF$ )	4000	V
$V_{ESD2}$	Electrostatic discharge on output pin only (human body model: $R = 330\Omega$ , $C = 150pF$ )	5000	V
$P_{tot}$	Power dissipation ( $T_c = 25^\circ C$ )	6	W
$T_j$	Operating junction temperature	Internally limited	$^\circ C$
$T_c$	Case operating temperature	Internally limited	$^\circ C$
$T_{stg}$	Storage temperature	-55 to 150	$^\circ C$

## 2.3

### Electrical characteristics for dual high side switch

$8V < V_{CC} < 36V$ ;  $-40^\circ C < T_j < 150^\circ C$ , unless otherwise specified.

**Table 6. Power outputs (per each channel)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$V_{CC}^{(1)}$	Operating supply voltage		5.5	13	36	V
$V_{USD}^{(1)}$	Undervoltage shutdown		3	4	5.5	V
$V_{OV}^{(1)}$	Overvoltage shutdown		36	-	-	V
$R_{ON}$	On-state resistance	$I_{OUT} = 1A$ ; $T_j = 25^\circ C$ $I_{OUT} = 1A$ ; $V_{CC} > 8V$	-	-	160 320	$m\Omega$ $m\Omega$
$I_S^{(1)}$	Supply current	Off-state; $V_{CC} = 13V$ ; $V_{IN} = V_{OUT} = 0V$ Off-state; $V_{CC} = 13V$ ; $V_{IN} = V_{OUT} = 0V$ ; $T_j = 25^\circ C$ On-state; $V_{CC} = 13V$ ; $V_{IN} = 5V$ ; $I_{OUT} = 0V$	- 5	12 7	40 25	$\mu A$ $mA$
$I_{L(off1)}$	Off-state output current	$V_{IN} = V_{OUT} = 0V$	0	-	50	$\mu A$
$I_{L(off2)}$	Off-state output current	$V_{IN} = 0V$ ; $V_{OUT} = 3.5V$	-75	-	0	$\mu A$
$I_{L(off3)}$	Off-state output current	$V_{IN} = V_{OUT} = 0V$ ; $V_{CC} = 13V$ ; $T_j = 125^\circ C$	-	-	5	$\mu A$
$I_{L(off4)}$	Off-state output current	$V_{IN} = V_{OUT} = 0V$ ; $V_{CC} = 13V$ ; $T_j = 25^\circ C$	-	-	3	$\mu A$

1. Per device.

**Table 7. Switching (per each channel) ( $V_{CC} = 13V$ )**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$t_{d(on)}$	Turn-on delay time	$R_L = 13\Omega$ from $V_{IN}$ rising edge to $V_{OUT} = 1.3V$	-	30	-	μs
$t_{d(off)}$	Turn-off delay time	$R_L = 13\Omega$ from $V_{IN}$ falling edge to $V_{OUT} = 11.7V$	-	30	-	μs
$dV_{OUT}/dt_{(on)}$	Turn-on voltage slope	$R_L = 13\Omega$ from $V_{OUT} = 1.3V$ to $V_{OUT} = 10.4V$	-	(1)	-	V/μs
$dV_{OUT}/dt_{(off)}$	Turn-off voltage slope	$R_L = 13\Omega$ from $V_{OUT} = 11.7V$ to $V_{OUT} = 1.3V$	-	(1)	-	V/μs

1. See relative diagram

**Table 8. Logic input (per each channel)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$V_{IL}$	Input low level		-	-	1.25	V
$I_{IL}$	Low level input current	$V_{IN} = 1.25V$	1	-	-	μA
$V_{IH}$	Input high level		3.25	-	-	V
$I_{IH}$	High level input current	$V_{IN} = 3.25V$	-	-	10	μA
$V_{I(hyst)}$	Input hysteresis voltage		0.5	-	-	V
$V_{ICL}$	Input clamp voltage	$I_{IN} = 1mA$ $I_{IN} = -1mA$	6	6.8 -0.7	8	V V

**Table 9. Status pin (per each channel)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$V_{STAT}$	Status low output voltage	$I_{STAT} = 1.6 mA$	-	-	0.5	V
$I_{LSTAT}$	Status leakage current	Normal operation; $V_{STAT} = 5V$	-	-	10	μA
$C_{STAT}$	Status pin input capacitance	Normal operation; $V_{STAT} = 5V$	-	-	100	pF
$V_{SCL}$	Status clamp voltage	$I_{STAT} = 1mA$ $I_{STAT} = -1mA$	6	6.8 -0.7	8	V V

**Table 10. Protections (per each channel)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$T_{TSD}$	Shutdown temperature		150	175	200	°C
$T_R$	Reset temperature		135	-	-	°C

**Table 10. Protections (per each channel) (continued)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$T_{\text{hyst}}$	Thermal hysteresis		7	15	-	°C
$t_{\text{SDL}}$	Status delay in overload conditions	$T_j > T_{\text{TSD}}$	-	-	20	μs
$I_{\text{lim}}$	Current limitation	$T_j = 125^{\circ}\text{C}$ $5.5\text{V} < V_{\text{CC}} < 36\text{V}$	7 8	10	13 13 13	A A A
$V_{\text{demag}}$	Turn-off output clamp voltage	$I_{\text{OUT}} = 1\text{A}; L = 6\text{mH}$	Vcc-41	Vcc-48	Vcc-55	V

Note:

To ensure long term reliability under heavy overload or short circuit conditions, protection and related diagnostic signals must be used together with a proper software strategy. If the device is subjected to abnormal conditions, this software must limit the duration and number of activation cycles.

**Table 11. Openload detection (per each channel)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$I_{\text{OL}}$	Openload on-state detection threshold	$V_{\text{IN}} = 5\text{V}$	20	40	80	mA
$t_{\text{DOL(on)}}$	Openload on-state detection delay	$I_{\text{OUT}} = 0\text{A}$	-	-	200	μs
$V_{\text{OL}}$	Openload off-state voltage detection threshold	$V_{\text{IN}} = 0\text{V}$	1.5	2.5	3.5	V
$t_{\text{DOL(off)}}$	Openload detection delay at turn-off		-	-	1000	μs

## 2.4 Electrical characteristics for low side switches

$-40^{\circ}\text{C} < T_j < 150^{\circ}\text{C}$ , unless otherwise specified.

**Table 12. Off-state**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$V_{\text{CLAMP}}$	Drain source clamp voltage	$V_{\text{IN}} = 0\text{V}; I_D = 3.5\text{A}$	40	45	55	V
$V_{\text{CLTH}}$	Drain source clamp threshold voltage	$V_{\text{IN}} = 0\text{V}; I_D = 2\text{mA}$	36	-	-	V
$V_{\text{INTH}}$	Input threshold voltage	$V_{\text{DS}} = V_{\text{IN}}; I_D = 1\text{mA}$	0.5	-	2.5	V
$I_{\text{ISS}}$	Supply current from input pin	$V_{\text{DS}} = 0\text{V}; V_{\text{IN}} = 5\text{V}$	-	100	150	μA

**Table 12. Off-state (continued)**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$V_{INCL}$	Input-source clamp voltage	$I_{IN} = 1\text{mA}$ $I_{IN} = -1\text{mA}$	6 -1.0	6.8	8 -0.3	V
$I_{DSS}$	Zero input voltage drain current ( $V_{IN} = 0\text{V}$ )	$V_{DS} = 13\text{V}; V_{IN} = 0\text{V}; T_j = 25^\circ\text{C}$ $V_{DS} = 25\text{V}; V_{IN} = 0\text{V}$	-	-	30 75	$\mu\text{A}$

**Table 13. On-state**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$R_{DS(on)}$	Static drain source on resistance	$V_{IN} = 5\text{V}; I_D = 3.5\text{A}; T_j = 25^\circ\text{C}$ $V_{IN} = 5\text{V}; I_D = 3.5\text{A}$	-	-	60 120	$\text{m}\Omega$

$T_j = 25^\circ\text{C}$ , unless otherwise specified.

**Table 14. Dynamic**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$g_{fs}^{(1)}$	Forward trans conductance	$V_{DD} = 13\text{V}; I_D = 3.5\text{A}$	-	9	-	S
$C_{OSS}$	Output capacitance	$V_{DS} = 13\text{V}; f = 1 \text{ MHz}; V_{IN} = 0\text{V}$	-	220	-	$\text{pF}$

1. Pulsed: Pulse duration = 300 $\mu\text{s}$ , duty cycle 1.5%

**Table 15. Switching**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 15\text{V}; I_D = 3.5\text{A}$ $V_{gen} = 5\text{V}; R_{gen} = R_{IN \text{ MIN}} = 150\Omega$	-	100	300	ns
$t_r$	Rise time		-	470	1500	ns
$t_{d(off)}$	Turn-off delay time		-	500	1500	ns
$t_f$	Fall time		-	350	1000	ns
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 15\text{V}; I_D = 3.5\text{A}$ $V_{gen} = 5\text{V}; R_{gen} = 2.2\text{K}\Omega$	-	0.75	2.3	$\mu\text{s}$
$t_r$	Rise time		-	4.6	14	$\mu\text{s}$
$t_{d(off)}$	Turn-off delay time		-	5.4	16	$\mu\text{s}$
$t_f$	Fall time		-	3.6	11	$\mu\text{s}$
$(dl/dt)_{on}$	Turn-on current slope	$V_{DD} = 15\text{V}; I_D = 3.5\text{A}$ $V_{gen} = 5\text{V}; R_{gen} = R_{IN \text{ MIN}} = 150\Omega$	-	6.5	-	$\text{A}/\mu\text{s}$
$Q_i$	Total input charge	$V_{DD} = 12\text{V}; I_D = 3.5\text{A}; V_{IN} = 5\text{V}$ $I_{gen} = 2.13\text{mA}$	-	18	-	nC

**Table 16. Source drain diode**

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$V_{SD}^{(1)}$	Forward on voltage	$I_{SD} = 3.5A; V_{IN} = 0V$	-	0.8	-	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 3.5A; dI/dt = 20A/\mu s$ $V_{DD} = 30V; L = 200\mu H$	-	220	-	ns
$Q_{rr}$	Reverse recovery charge		-	0.28	-	$\mu C$
$I_{RRM}$	Reverse recovery current		-	2.5	-	A

1. Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5%

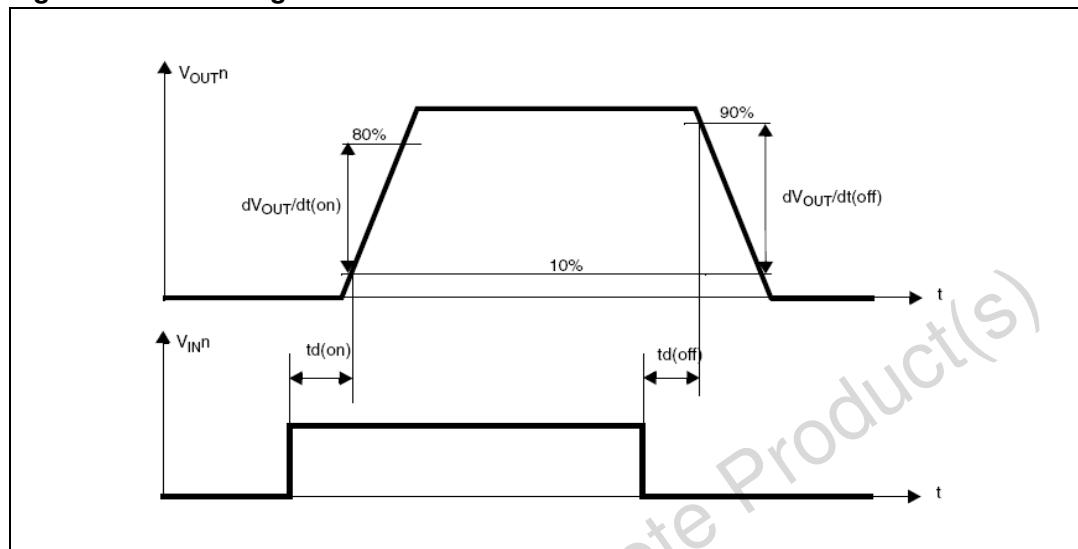
$-40^{\circ}C < T_j < 150^{\circ}C$ , unless otherwise specified.

**Table 17. Protections**

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
$I_{lim}$	Drain current limit	$V_{IN} = 5V; V_{DS} = 13V$	6	9	12	A
		$V_{IN} = 5V; V_{DS} = 13V; T_j = 125^{\circ}C$	6.5	12	12	A
$t_{dlim}$	Step response current limit	$V_{IN} = 5V; V_{DS} = 13V$	-	4	-	$\mu s$
$T_{jsh}$	Over temperature shutdown		150	175	-	$^{\circ}C$
$T_{jrs}$	Over temperature reset		135	-	-	$^{\circ}C$
$I_{gf}$	Fault sink current	$V_{IN} = 5V; V_{DS} = 13V; T_j = T_{jsh}$	-	15	-	mA
$E_{as}$	Single pulse avalanche energy	Starting $T_j = 25^{\circ}C; V_{DD} = 24V$ $V_{IN} = 5V; R_{gen} = R_{IN MIN} = 150\Omega$ ; $L = 24mH$	200	-	-	mJ

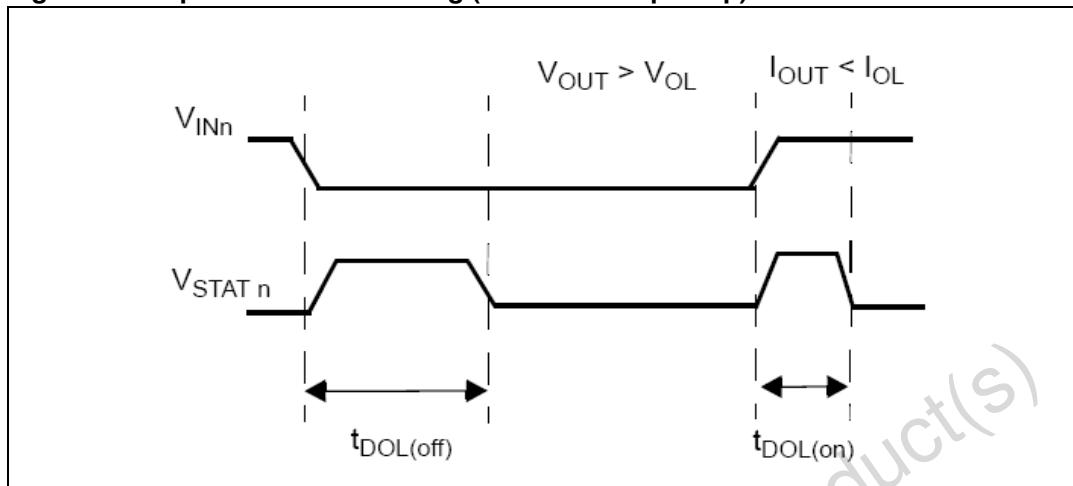
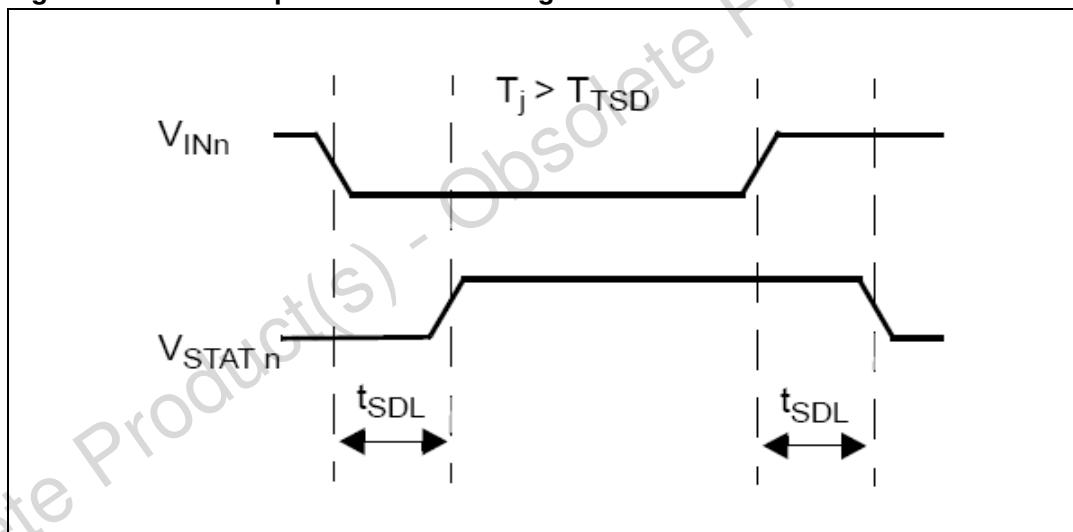
## 2.5 Dual high-side switch timing data

**Figure 3.** Switching time waveforms



**Table 18.** Truth table

Conditions	Input	Output	Status
Normal operation	L	L	H
	H	H	H
Current limitation	L	L	H
	H	X	$(T_j < T_{TSD}) H$
	H	X	$(T_j > T_{TSD}) L$
Over temperature	L	L	H
	H	L	L
Undervoltage	L	L	X
	H	L	X
Overvoltage	L	L	H
	H	L	H
Output voltage $> V_{OL}$	L	H	L
	H	H	H
Output current $< I_{OL}$	L	L	H
	H	H	L

**Figure 4. Open-load status timing (with external pull-up)****Figure 5. Over temperature status timing**

## 2.6 Electrical characterization for dual high side switch

Figure 6. Off-state output current

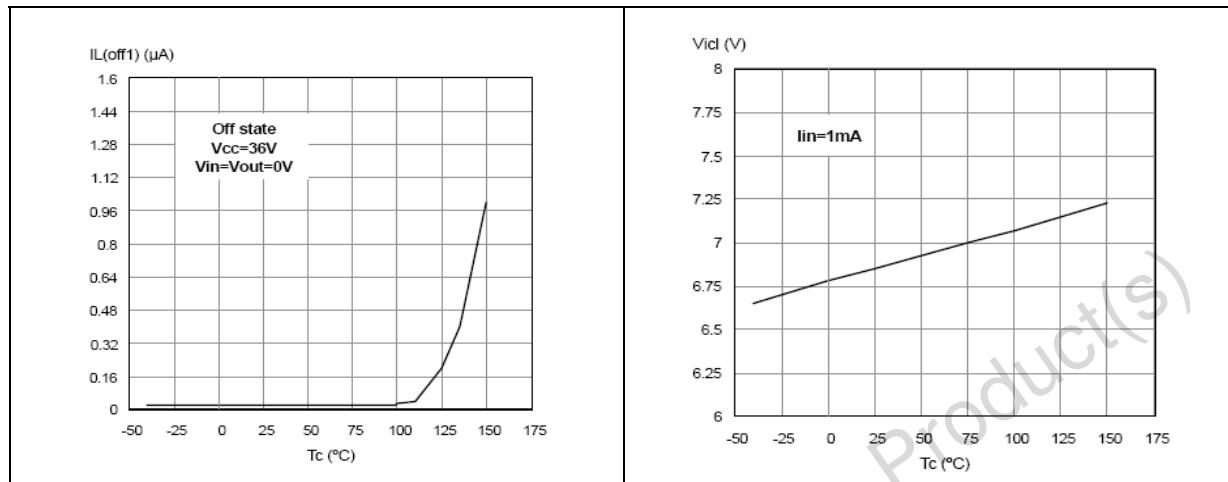


Figure 8. High level input current

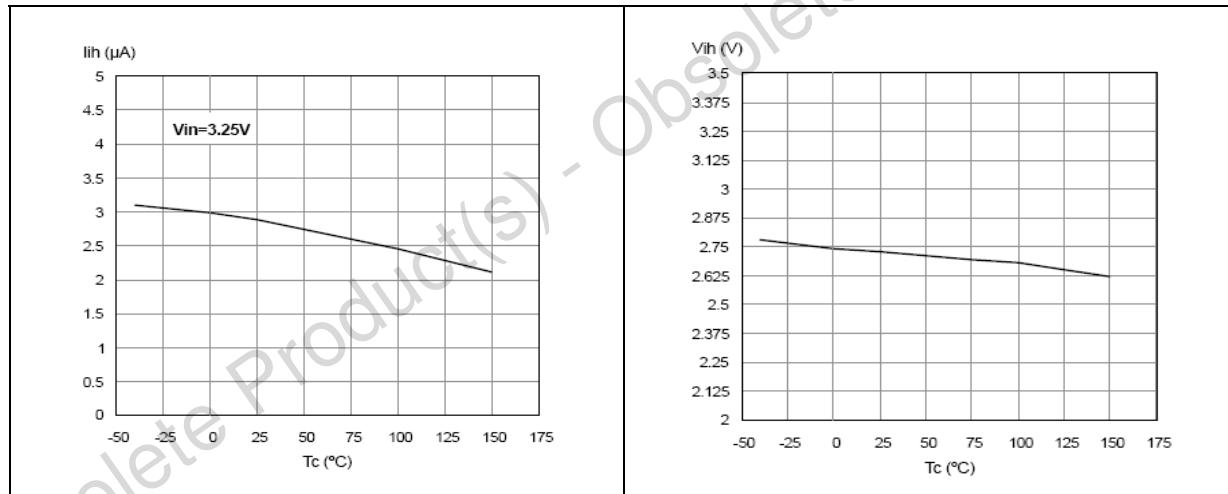


Figure 10. Input low level voltage

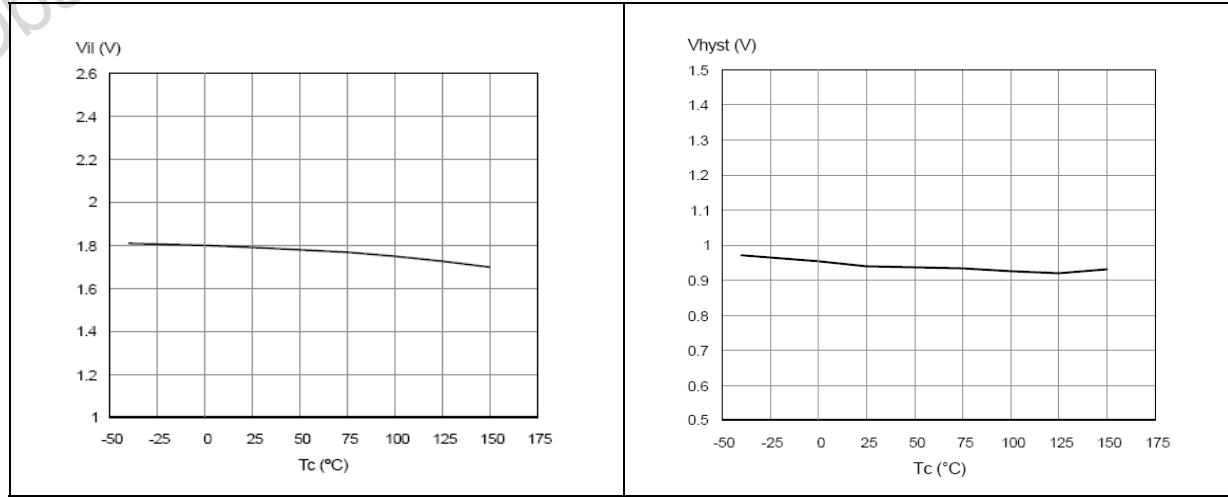


Figure 7. Input clamp voltage

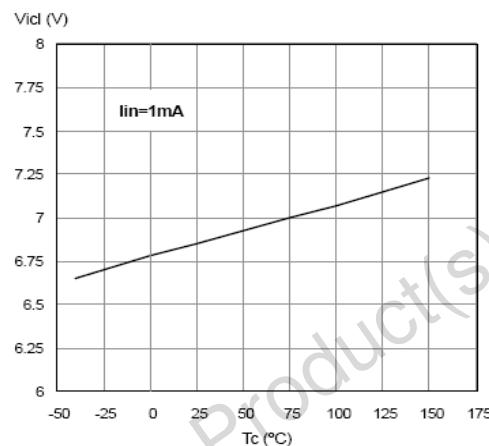


Figure 9. Input high level voltage

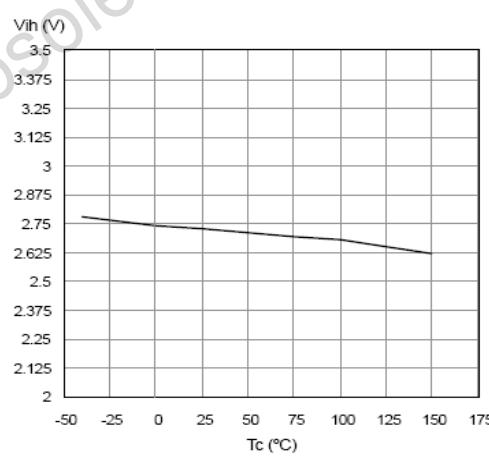
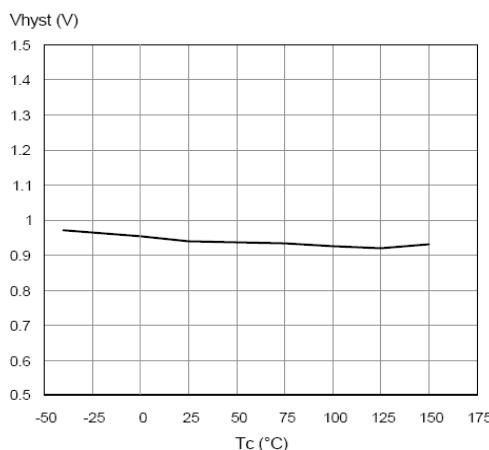
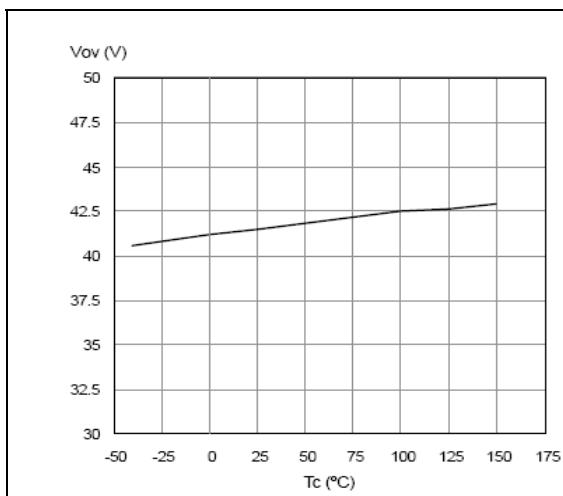
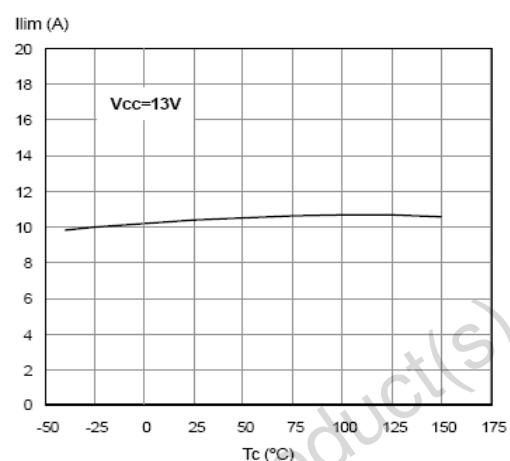
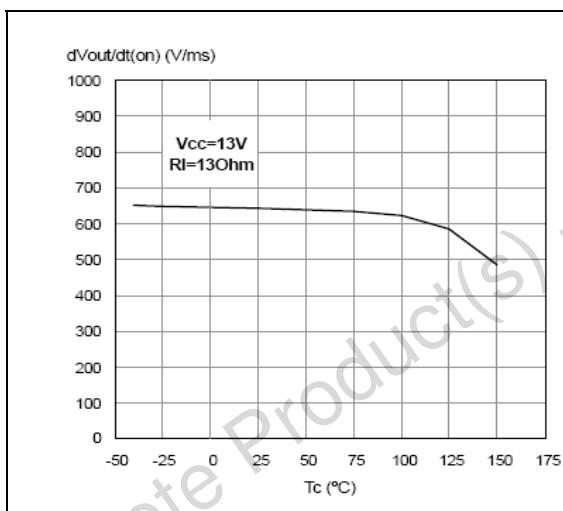
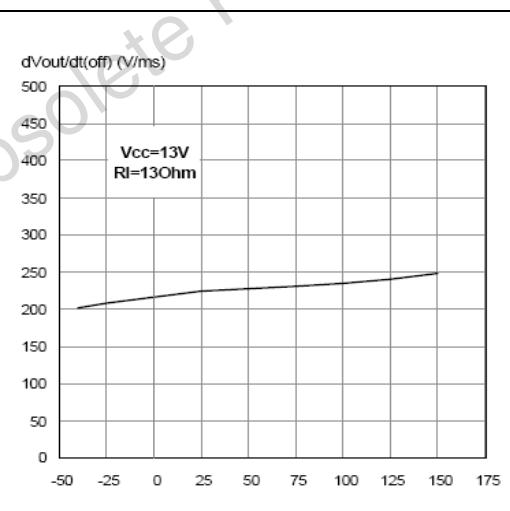
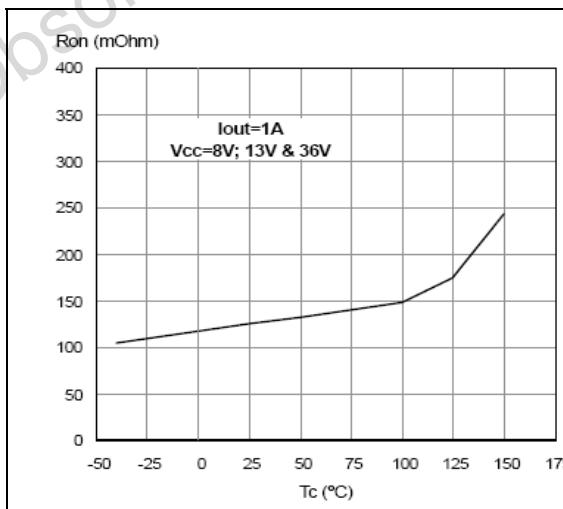
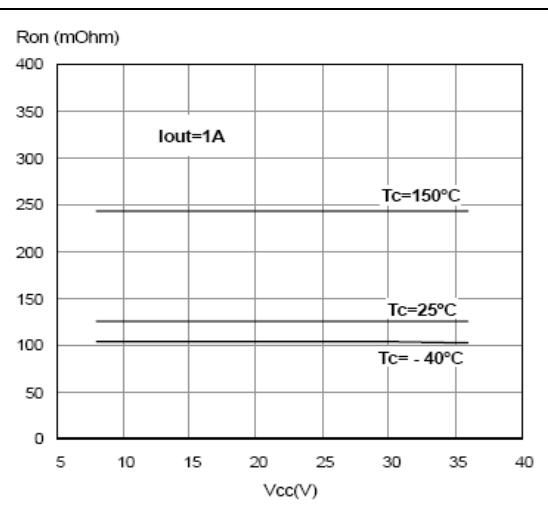
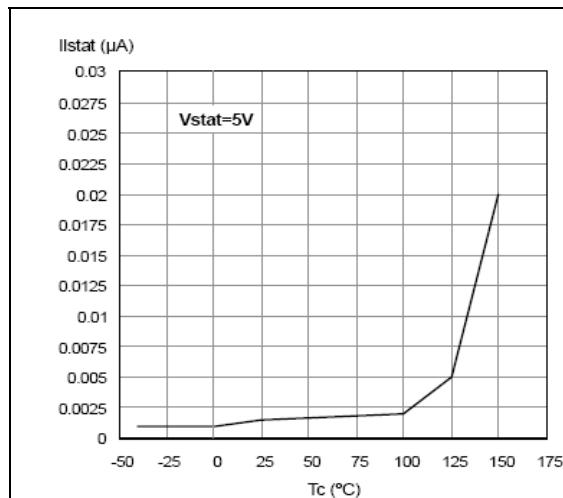
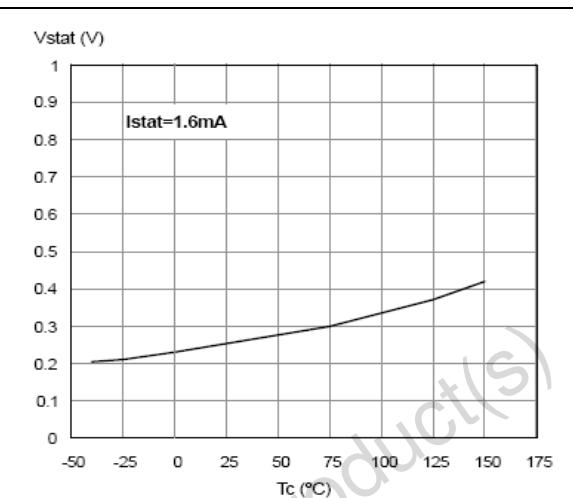
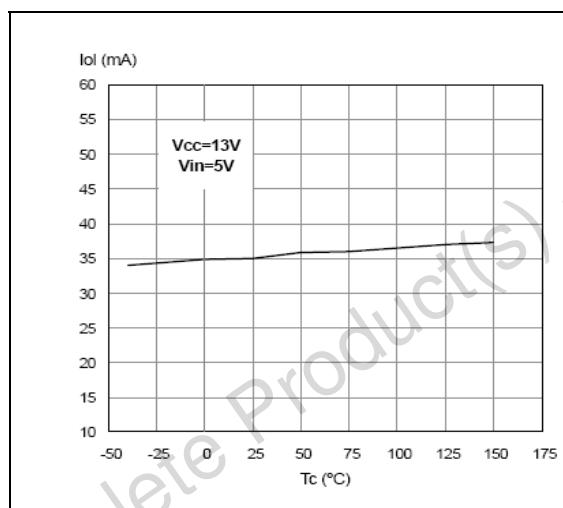
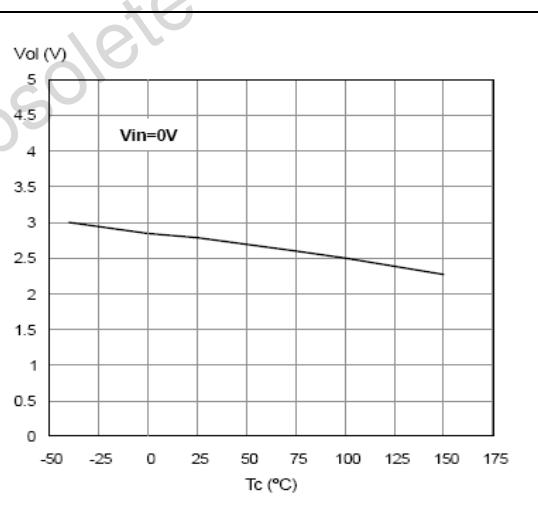
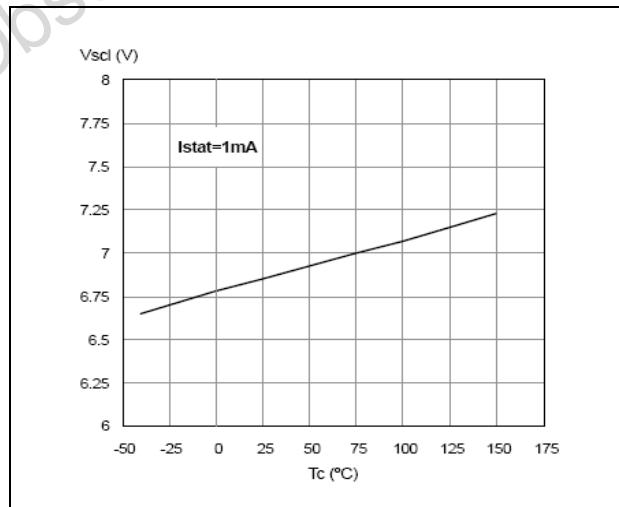


Figure 11. Input hysteresis voltage



**Figure 12. Overvoltage shutdown****Figure 13.  $I_{LIM}$  vs  $T_{case}$** **Figure 14. Turn-on voltage slope****Figure 15. Turn-off voltage slope****Figure 16. On-state resistance vs  $T_{case}$** **Figure 17. On-state resistance vs  $V_{cc}$** 

**Figure 18. Status leakage current****Figure 19. Status low output voltage****Figure 20. Openload on-state detection threshold****Figure 21. Openload off-state voltage detection threshold****Figure 22. Status clamp voltage**

## 2.7 Electrical characterization for low side switches

Figure 23. Static drain source on resistance

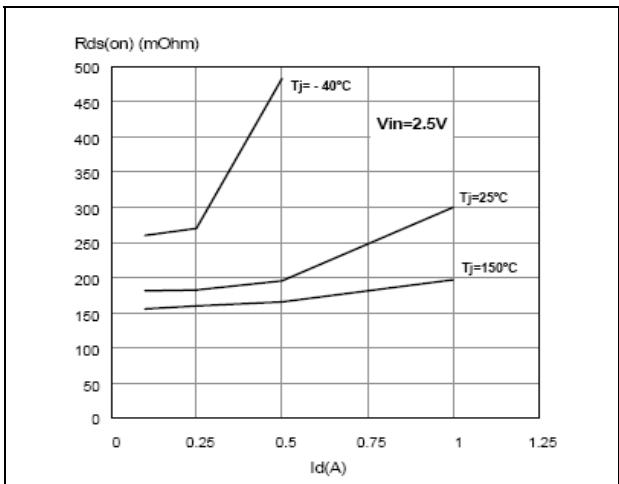


Figure 24. Derating curve

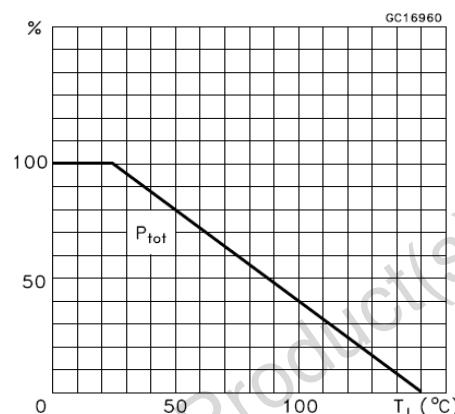


Figure 25. Transconductance

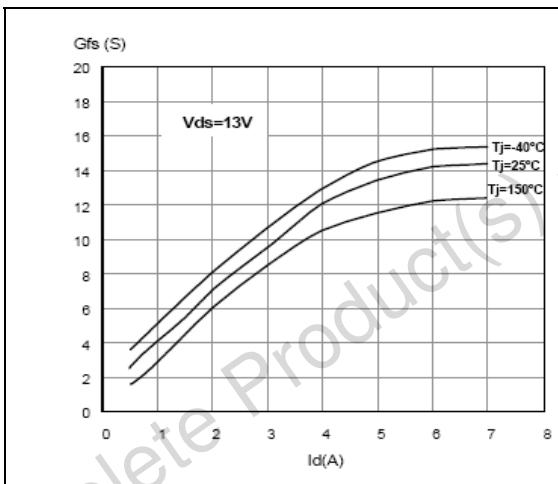
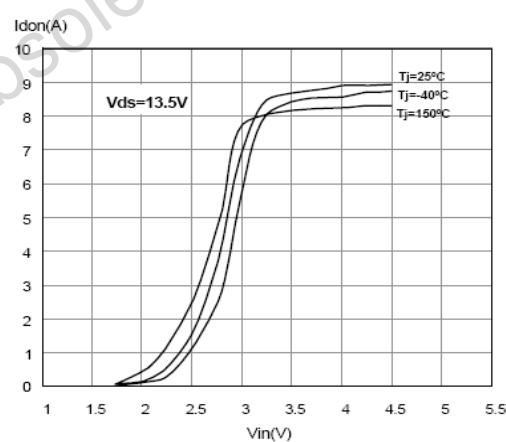
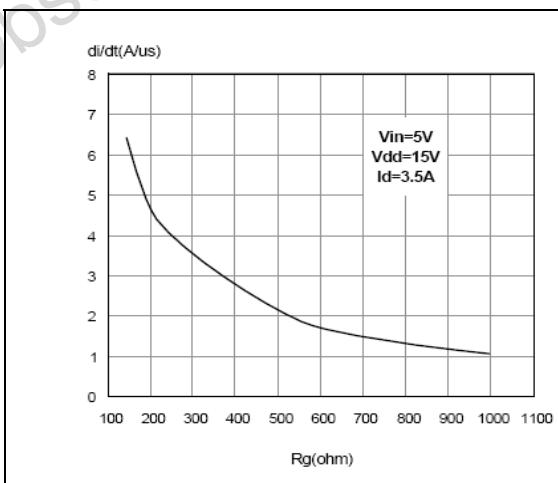
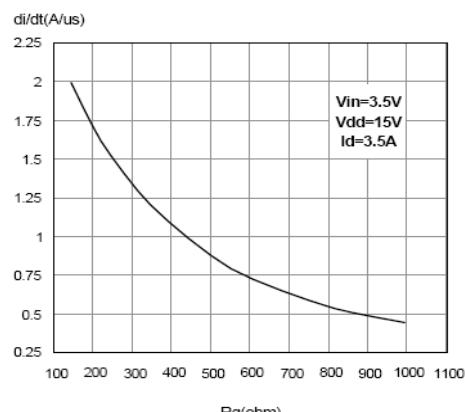
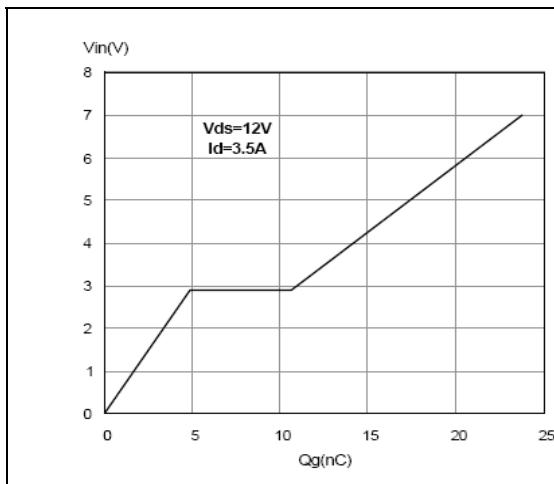
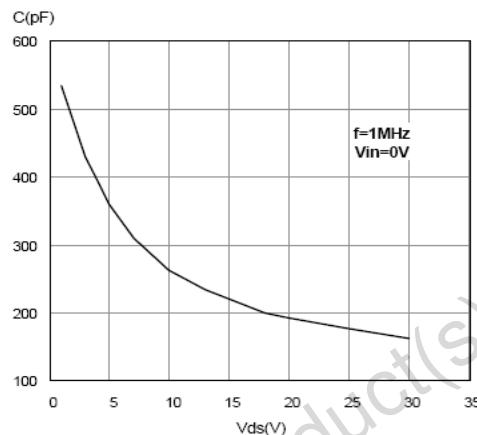
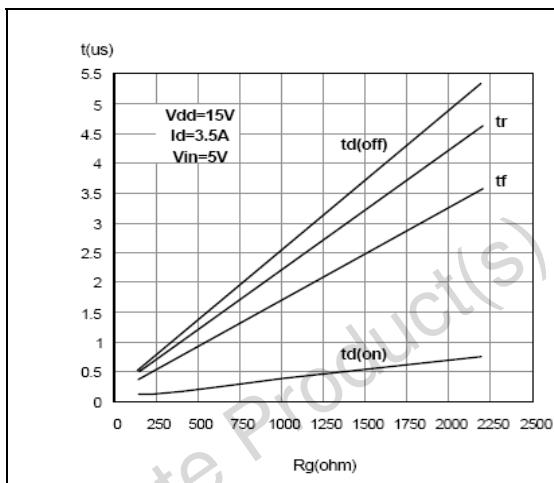
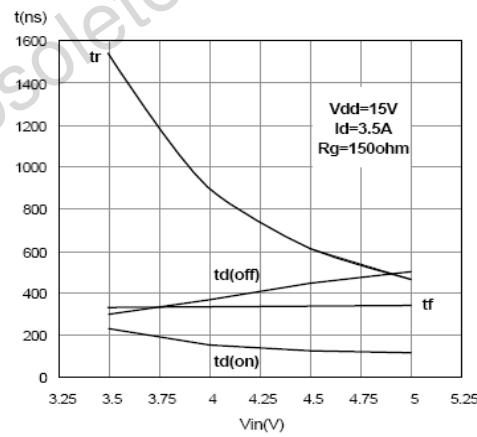
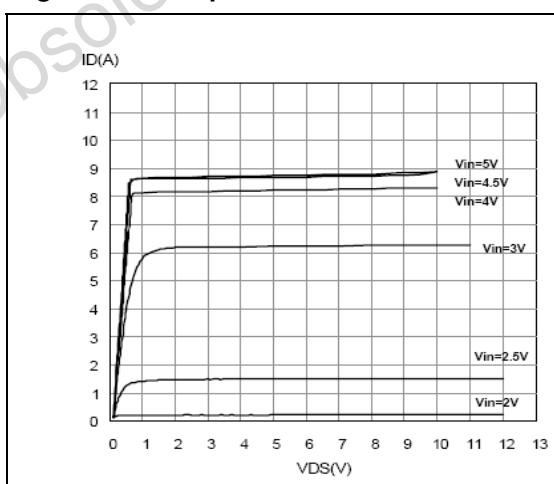
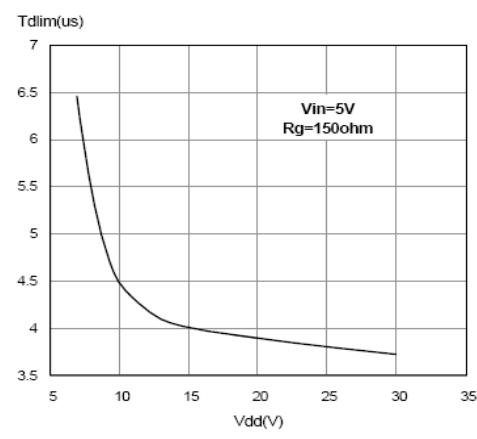
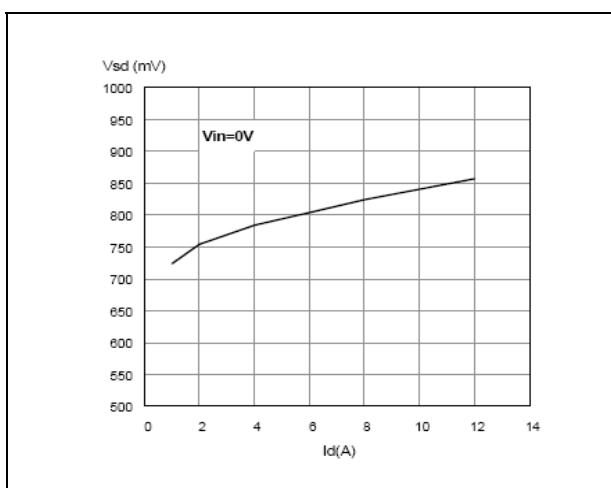


Figure 26. Transfer characteristics

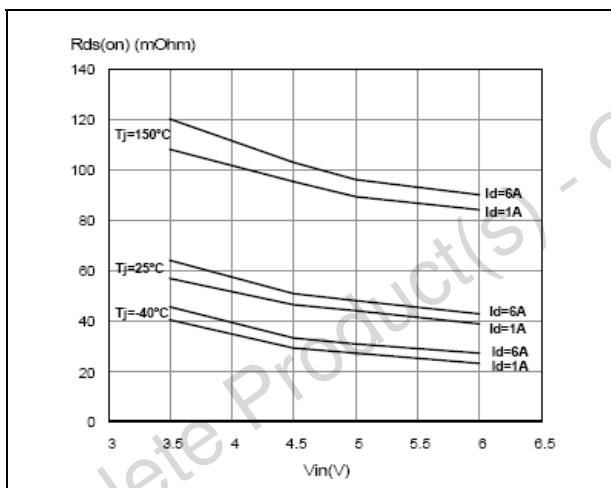
Figure 27. Turn-on current slope ( $V_{in}=5\text{V}$ )Figure 28. Turn-on current slope ( $V_{in}=3.5\text{V}$ )

**Figure 29. Input voltage vs input charge****Figure 30. Capacitance variations****Figure 31. Switching time resistive load ( $V_{in}=5V$ )****Figure 32. Switching time resistive load ( $R_g=10\Omega$ )****Figure 33. Output characteristics****Figure 34. Step response current limit**

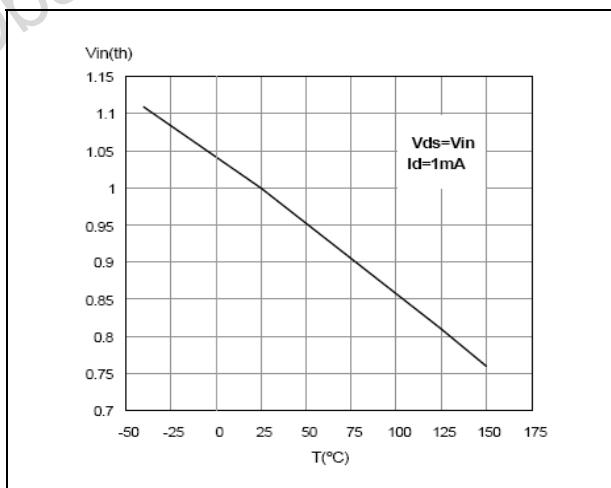
**Figure 35. Source drain diode forward characteristics**



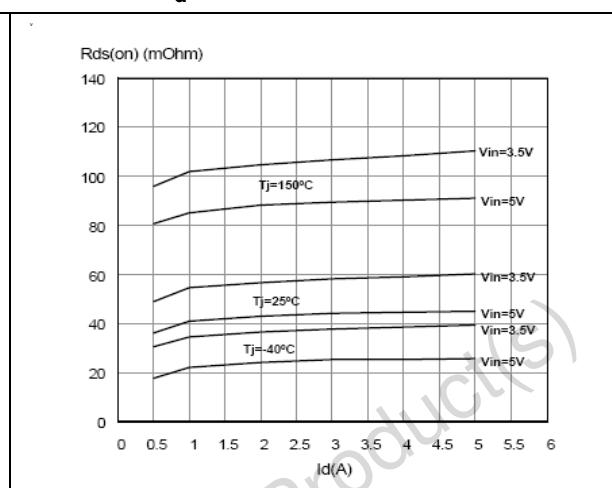
**Figure 37. Static drain source on resistance vs input voltage ( $I_d=7A$ )**



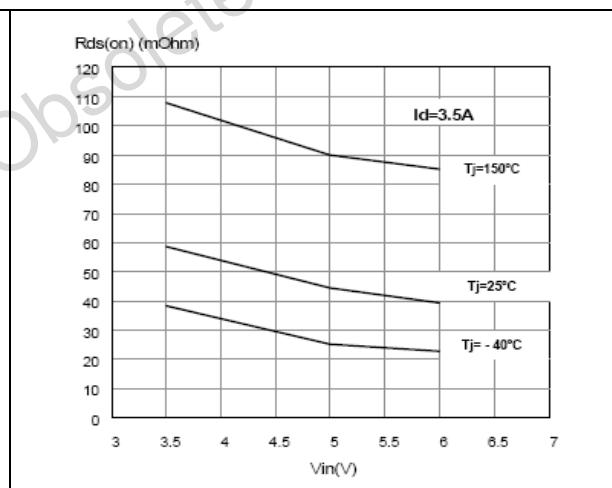
**Figure 39. Normalized input threshold voltage vs temperature**



**Figure 36. Static drain source on resistance vs  $I_d$**



**Figure 38. Static drain source on resistance vs input voltage**



**Figure 40. Normalized on resistance vs temperature**

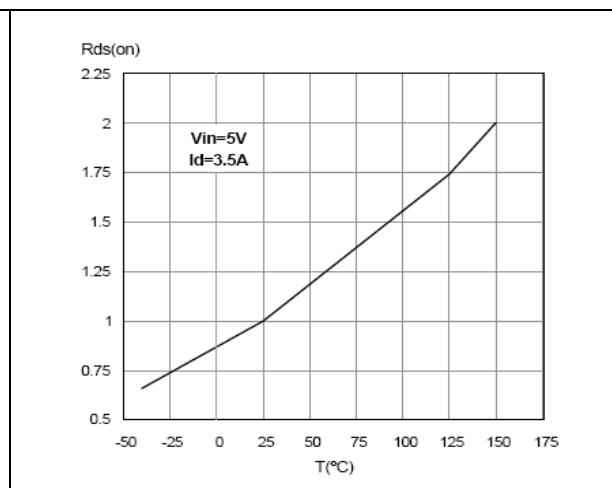


Figure 41. Turn-off drain source voltage slope ( $V_{in}=3.5V$ )    Figure 42. Turn-off drain source voltage slope ( $V_{in}=5V$ )

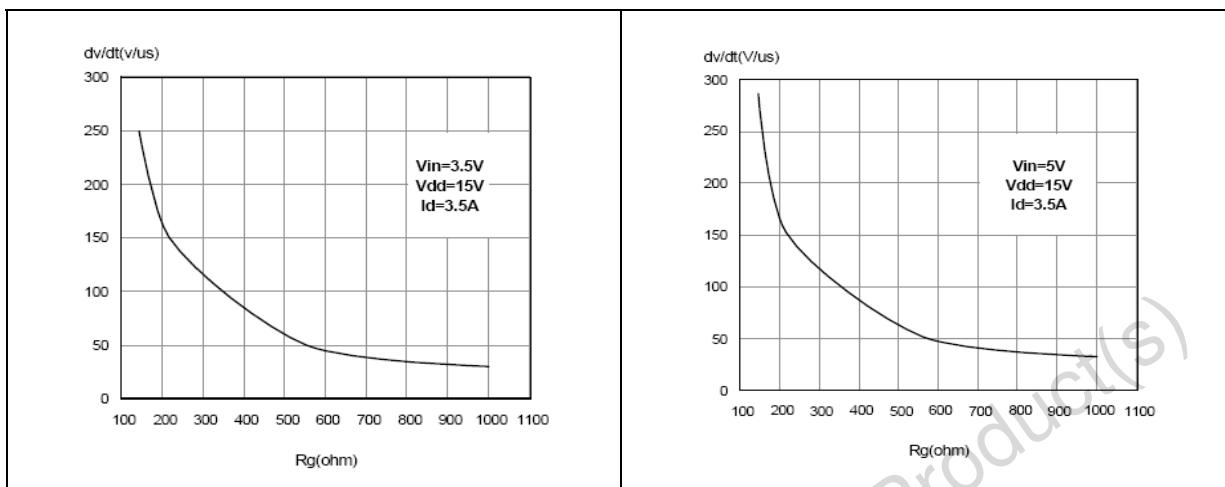
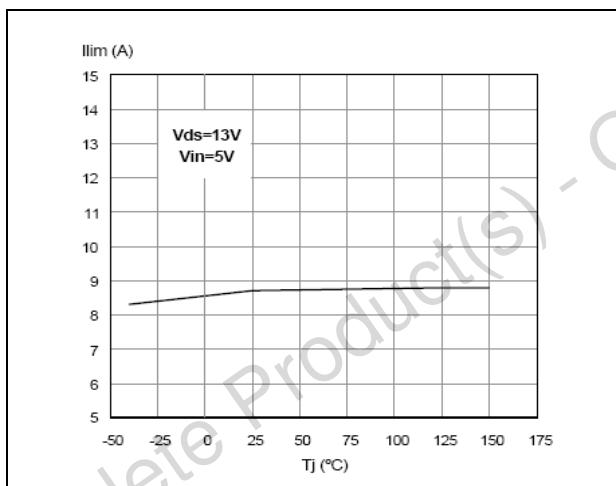
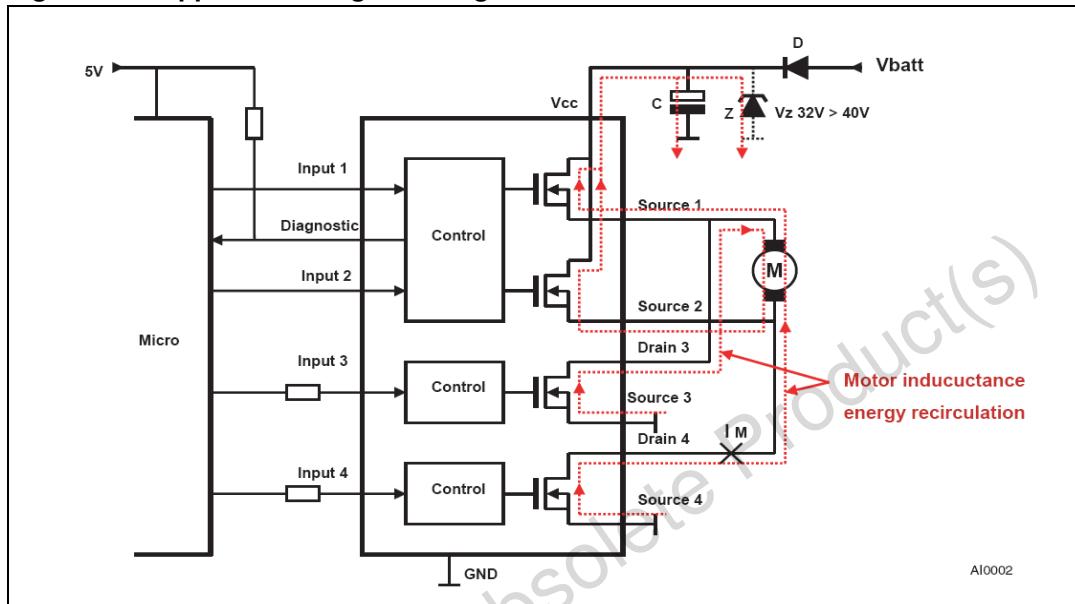


Figure 43. Current limit vs junction temperature



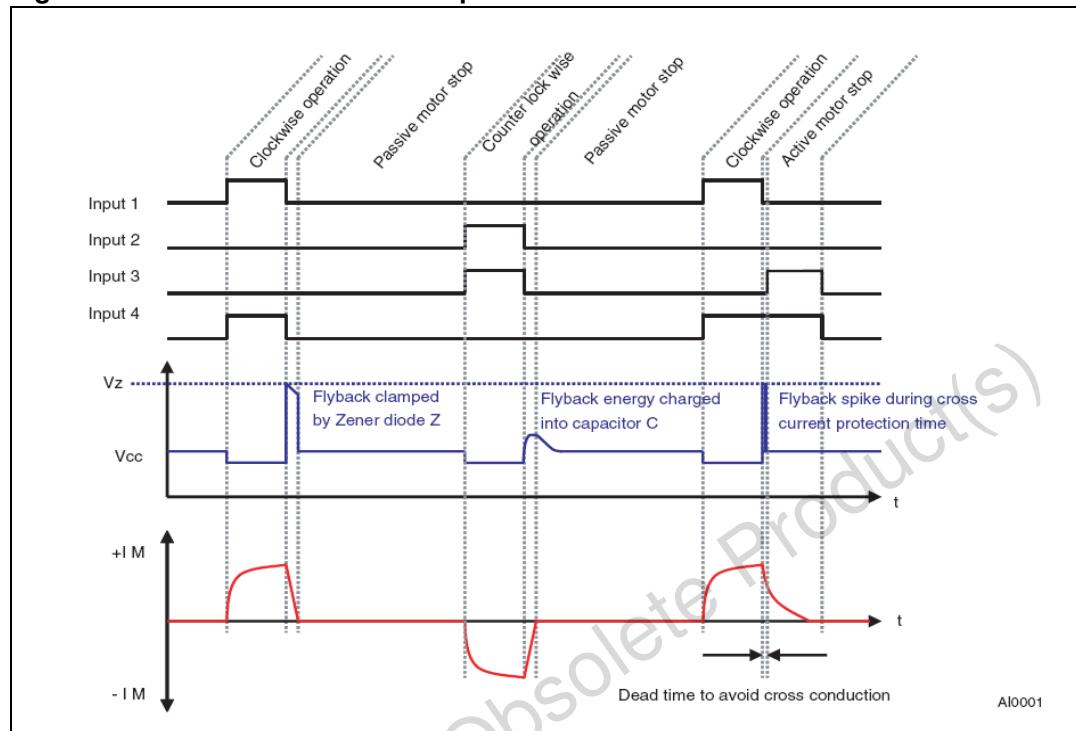
### 3 Application recommendations

Figure 44. Application diagram bridge drivers



Most motor bridge drivers use a reverse battery protection diode (D) inside the supply rail. This diode prevents a reverse current flow back to  $V_{BATT}$  in case the bridge becomes disabled via the logic inputs while motor inductance still carries energy. In order to prevent a hazardous overvoltage at circuit supply terminal ( $V_{CC}$ ), a blocking capacitor (C) is needed to limit the voltage overshoot. As basic orientation,  $50\mu F$  per 1A load current is recommended. As an alternative, a Zener protection (Z) is also suitable.

Even if a reverse polarity diode is not present, it is recommended to use a capacitor or Zener at  $V_{CC}$  because a similar problem appears in case the supply terminal of the module has intermittent electrical contact to the battery or gets disconnected while the motor is operating.

**Figure 45. Recommended motor operation**

**Figure 46. Waveforms**